

OKI Semiconductor

FEDR27V802F-01-03

Issue Date: Dec. 8, 2004

MR27V802F

524,288–Word x 16–Bit or 1,048,576–Word x 8–Bit One Time PROM

GENERAL DESCRIPTION

The MR27V802F is a 8Mbit electrically One Time Programmable Read-Only Memory that can be electrically switched between 524,288-word × 16-bit and 1,048,576-word × 8-bit by the state of the BYTE# pin. The MR27V802F supports high speed asynchronous read operation using a single 3.3V power supply.

FEATURES

- 524,288-word × 16-bit/1,048,576-word × 8-bit electrically switchable configuration
- +3.3 V power supply
- Access time 70 nS MAX
- Operating current 18 mA MAX (5MHz)
- Standby current 5 μ A MAX
- Input/Output TTL compatible
- Tri-state output
- Packages:

44-pin plastic SOP (SOP44-P-600-1.27-K)

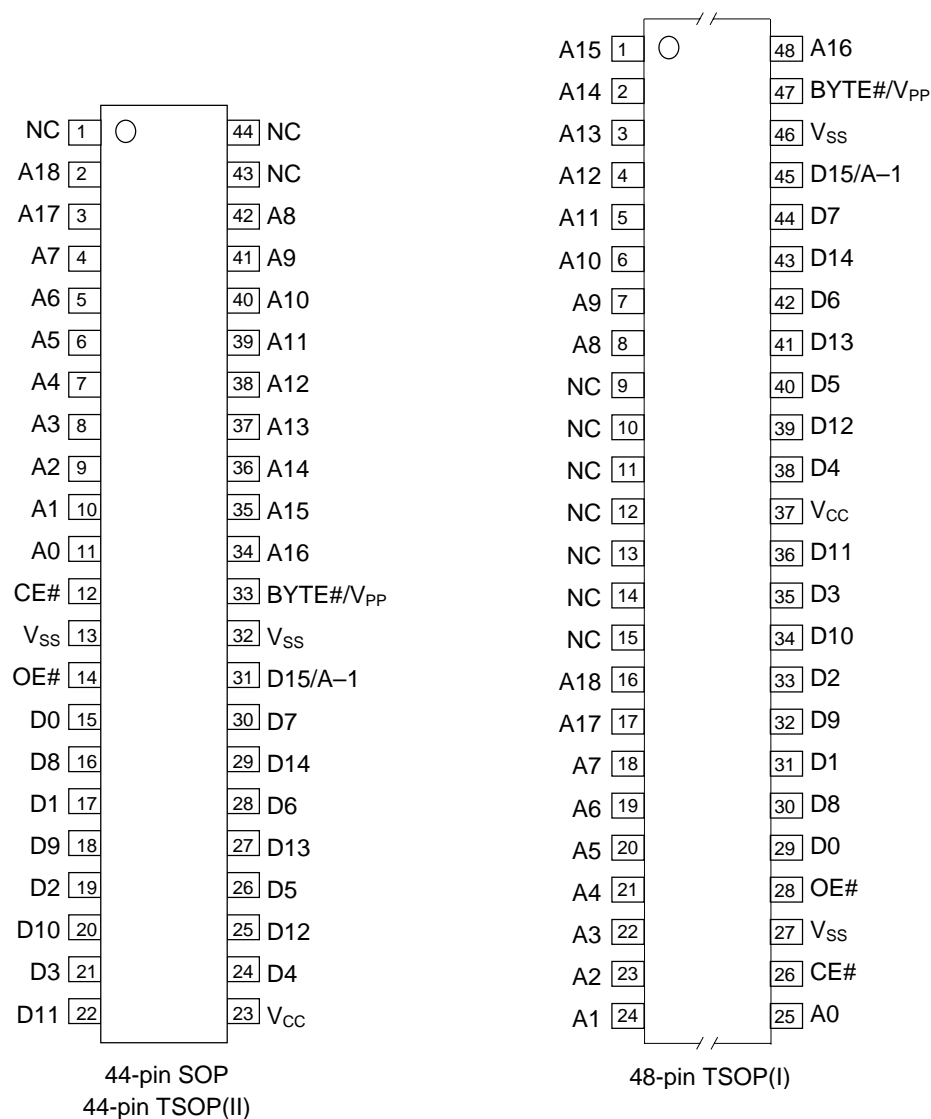
(Product Name : MR27V802FMA)

48-pin plastic TSOP (TSOP(1)48-P-1220-0.50-1K)

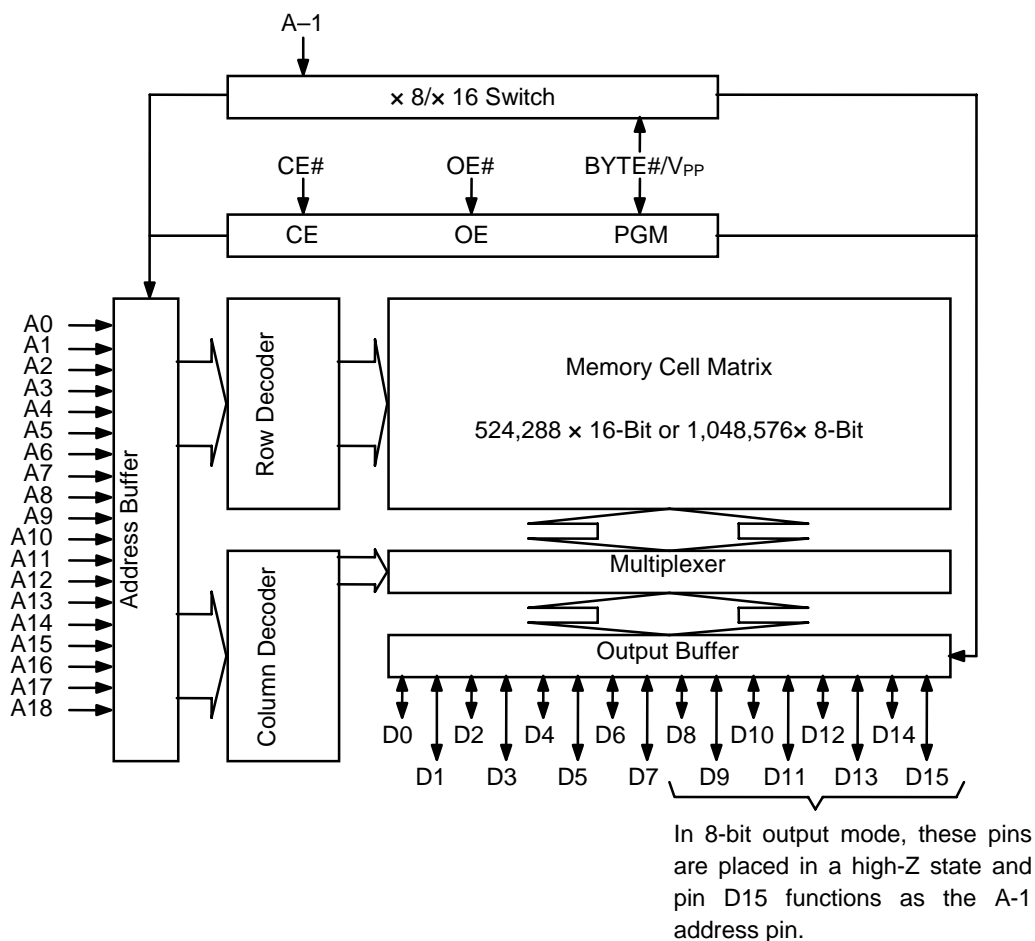
(Product Name : MR27V802FTN)

44-pin plastic TSOP (TSOP II 44-P-400-0.80-K)

(Product Name : MR27V802FTP)

PIN CONFIGURATION (TOP VIEW)

Pin name	Functions
D15/A-1	Data output/Address input
A0 to A18	Address input
D0 to D14	Data output
CE#	Chip enable
OE#	Output enable
BYTE#/V _{PP}	Mode switch/Program power supply voltage
V _{CC}	Power supply voltage
V _{SS}	GND
NC	Non connection

BLOCK DIAGRAM**FUNCTION TABLE**

Mode	CE#	OE#	BYTE#/V _{PP}	V _{CC}	D0 to D7	D8 to D14	D15/A-1	
Read (16-Bit)	L	L	H	3.3 V	D _{OUT}			
Read (8-Bit)	L	L	L		D _{OUT}	Hi-Z	L/H	
Output disable	L	H	H		Hi-Z			*
			L					
Standby	H	*	H		Hi-Z			*
			L					
Program	L	H	8.0 V	4.0 V	D _{IN}	Hi-Z	L/H	
Program inhibit	H	H			Hi-Z	Hi-Z	L/H	
Program verify	H	L			D _{OUT}	Hi-Z	L/H	

*: Don't Care (H or L)

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Condition	Value	Unit
Operating temperature under bias	Ta	—	0 to 70	°C
Storage temperature	Tstg		−55 to 125	°C
Input voltage	V _I	relative to V _{SS}	−0.5 to V _{CC} +0.5	V
Output voltage	V _O		−0.5 to V _{CC} +0.5	V
Power supply voltage	V _{CC}		−0.5 to 5	V
Program power supply voltage	V _{PP}		−0.5 to 9.0	V
Power dissipation per package	P _D	Ta = 25°C	1.0	W
Output short circuit current	I _{OS}	—	10	mA

RECOMMENDED OPERATING CONDITIONS

(Ta = 0 to 70°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
V _{CC} power supply voltage	V _{CC}	V _{CC} = 3.0 to 3.6 V	3.0	—	3.6	V
V _{PP} power supply voltage	V _{PP}		−0.5	—	V _{CC} +0.5	V
Input “H” level	V _{IH}		2.2	—	V _{CC} +0.5*	V
Input “L” level	V _{IL}		−0.5**	—	0.6	V

Voltage is relative to V_{SS}.* : V_{CC}+1.5V(Max.) when pulse width of overshoot is less than 10ns.

** : −1.5V(Min.) when pulse width of undershoot is less than 10ns.

ELECTRICAL CHARACTERISTICS

DC Characteristics

($V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, $T_a = 0\text{ to }70^\circ\text{C}$)

parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I_{LI}	$V_I = 0\text{ to }V_{CC}$	—	—	5	μA
Output leakage current	I_{LO}	$V_O = 0\text{ to }V_{CC}$	—	—	5	μA
V_{CC} power supply current (Standby)	I_{CCSC}	$CE\# = V_{CC}$	—	—	5	μA
	I_{CCST}	$CE\# = V_{IH}$	—	—	1	mA
V_{CC} power supply current (Read)	I_{CCA}	$CE\# = V_{IL}$, $OE\# = V_{IH}$ $f=5\text{MHz}$	—	—	18	mA
V_{PP} power supply current	I_{PP}	$V_{PP} = V_{CC}$	—	—	10	μA
Input "H" level	V_{IH}	—	2.2	—	$V_{CC}+0.5^*$	V
Input "L" level	V_{IL}	—	-0.5**	—	0.6	V
Output "H" level	V_{OH}	$I_{OH} = -1\text{ mA}$	2.4	—	—	V
Output "L" level	V_{OL}	$I_{OL} = 2\text{ mA}$	—	—	0.4	V

Voltage is relative to V_{SS} .

* : $V_{CC}+1.5\text{V}(\text{Max.})$ when pulse width of overshoot is less than 10ns.

** : $-1.5\text{V}(\text{Min.})$ when pulse width of undershoot is less than 10ns.

AC Characteristics

($V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$, $T_a = 0\text{ to }70^\circ\text{C}$)

Parameter	Symbol	Condition	Min.	Max.	Unit
Address cycle time	t_C	—	70	—	ns
Address access time	t_{ACC}	$CE\# = OE\# = V_{IL}$	—	70	ns
CE# access time	t_{CE}	$OE\# = V_{IL}$	—	70	ns
OE# access time	t_{OE}	$CE\# = V_{IL}$	—	25	ns
Output disable time	t_{CHZ}	$OE\# = V_{IL}$	0	20	ns
	t_{OHZ}	$CE\# = V_{IL}$	0	20	ns
Output hold time	t_{OH}	$CE\# = OE\# = V_{IL}$	0	—	ns

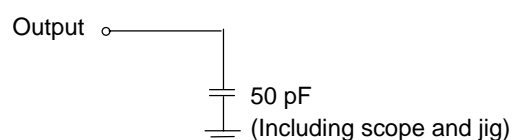
Measurement conditions

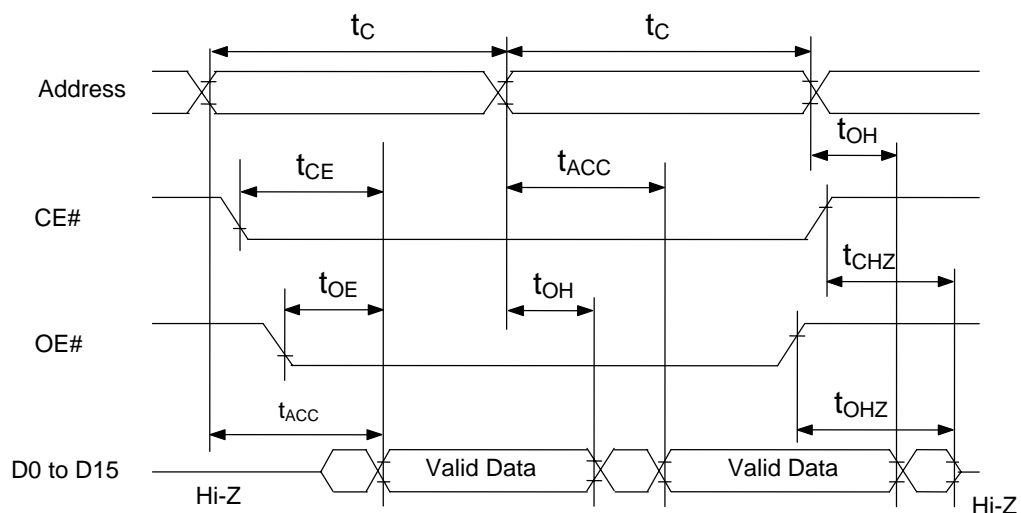
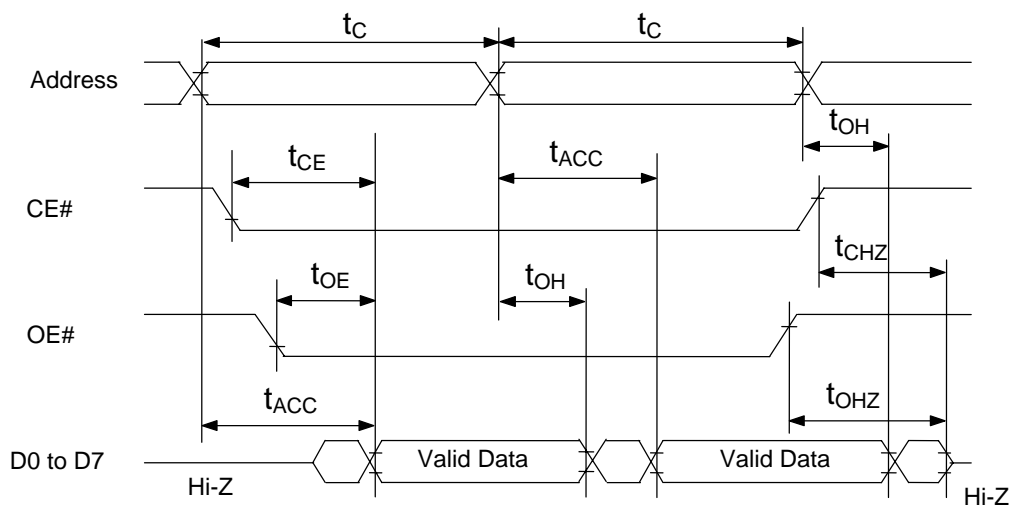
Input signal level ----- 0 V/3 V

Input timing reference level----- 1/2V_{CC}

Output load ----- 50 pF

Output timing reference level ----- 1/2V_{CC}



TIMING CHART (READ CYCLE)**16-Bit Read Mode (BYTE# = V_{IH})****8-Bit Read Mode (BYTE# = V_{IL})**

ELECTRICAL CHARACTERISTICS (PROGRAMMING OPERATION)**DC Characteristics**

(Ta = 25°C ± 5°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input leakage current	I _{LI}	V _I = V _{CC} +0.5 V	—	—	10	μA
V _{PP} power supply current (Program)	I _{PP2}	CE# = V _{IL}	—	—	50	mA
V _{CC} power supply current	I _{CC}	—	—	—	50	mA
Input “H” level	V _{IH}	—	3.0	—	V _{CC} +0.5	V
Input “L” level	V _{IL}	—	−0.5	—	0.8	V
Output “H” level	V _{OH}	I _{OH} = −400 μA	2.4	—	—	V
Output “L” level	V _{OL}	I _{OL} = 2.1 mA	—	—	0.45	V
Program voltage	V _{PP}	—	7.75	8.0	8.25	V
V _{CC} power supply voltage	V _{CC}	—	3.9	4.0	4.1	V

Voltage is relative to V_{SS}.**AC Characteristics**(V_{CC} = 4.0 V ± 0.1 V, BYTE#/V_{PP} = 8.0 V ± 0.25 V, Ta = 25°C ± 5°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Address set-up time	t _{AS}	—	100	—	—	ns
OE# set-up time	t _{OES}	—	2	—	—	μs
Data set-up time	t _{DS}	—	100	—	—	ns
Address hold time	t _{AH}	—	2	—	—	μs
Data hold time	t _{DH}	—	100	—	—	ns
Output float delay time from OE#	t _{OHZ}	—	0	—	100	ns
V _{PP} voltage set-up time	t _{VS}	—	2	—	—	μs
Program pulse width	t _{PW}	—	9	10	11	μs
Data valid from OE#	t _{OE}	—	—	—	100	ns
Address hold from OE# high	t _{AOH}	—	0	—	—	ns

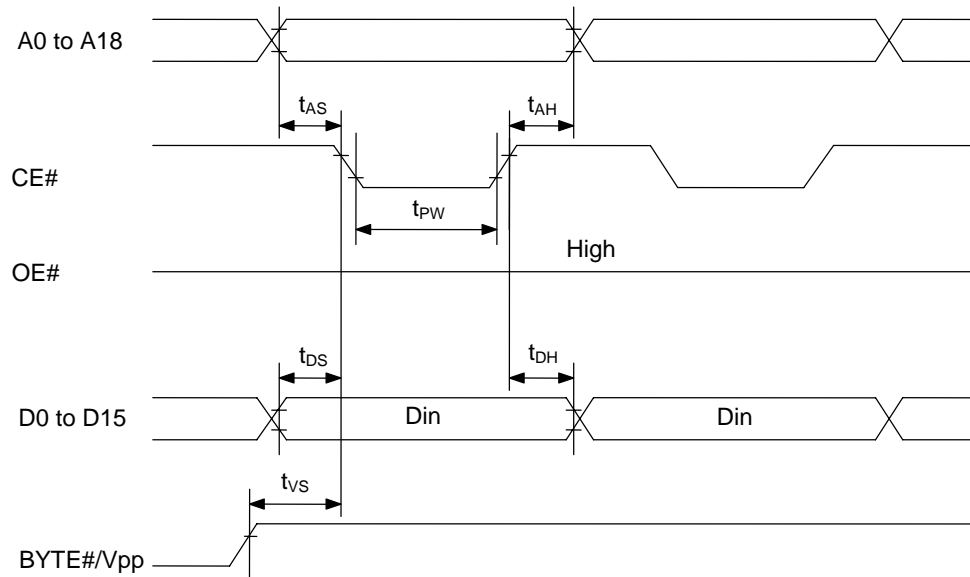
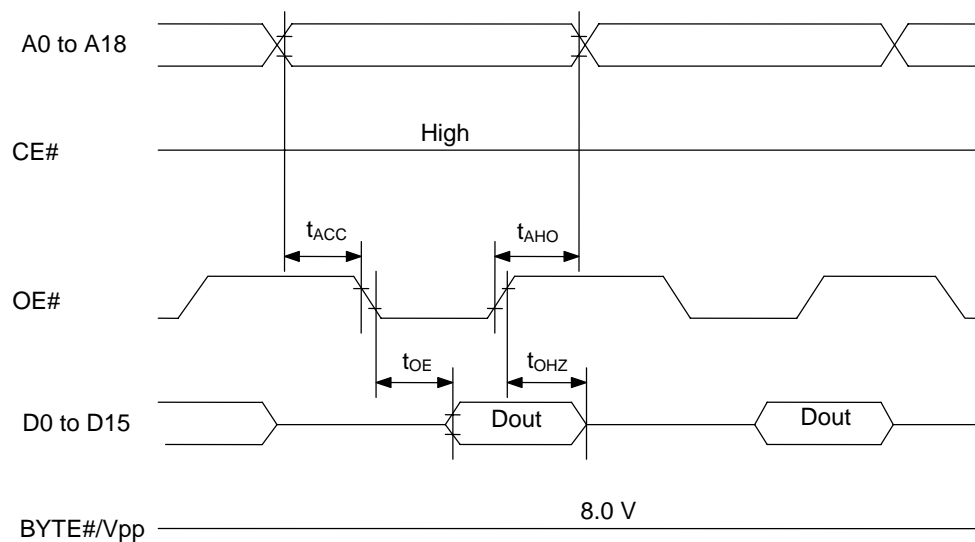
Pin Check Function

Pin Check Function is to check contact between each device-pin and each socket-lead with EPROM programmer. Setting up address as following condition call the preprogrammed codes on device outputs.

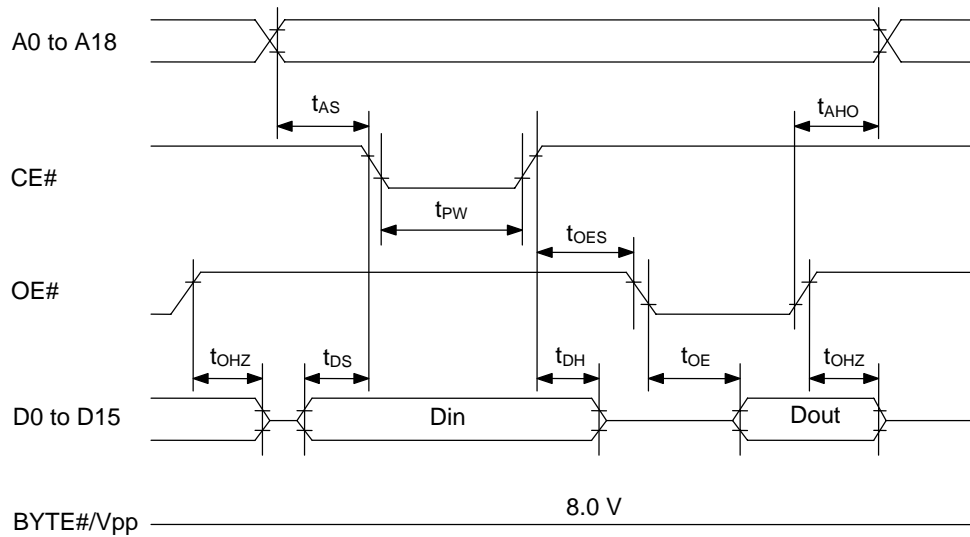
(V_{CC} = 3.3 V ± 0.1 V, CE# = V_{IL}, OE# = V_{IL}, BYTE#/V_{PP} = V_{IH}, Ta = 25°C ± 5°C)

A0	A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11	A12	A13	A14	A15	A16	A17	A18	DATA
0	1	0	1	0	1	0	1	0	V _H *	0	1	0	1	0	1	0	0	1	00FF
1	0	1	0	1	0	1	0	1	V _H *	1	0	1	0	1	0	1	1	0	FF00
Other conditions																			FFFF

*: V_H = 7.0V ± 0.25 V

Consecutive Programming Waveforms**Consecutive Program Verify Waveforms**

Program And Program Verify Cycle Waveforms

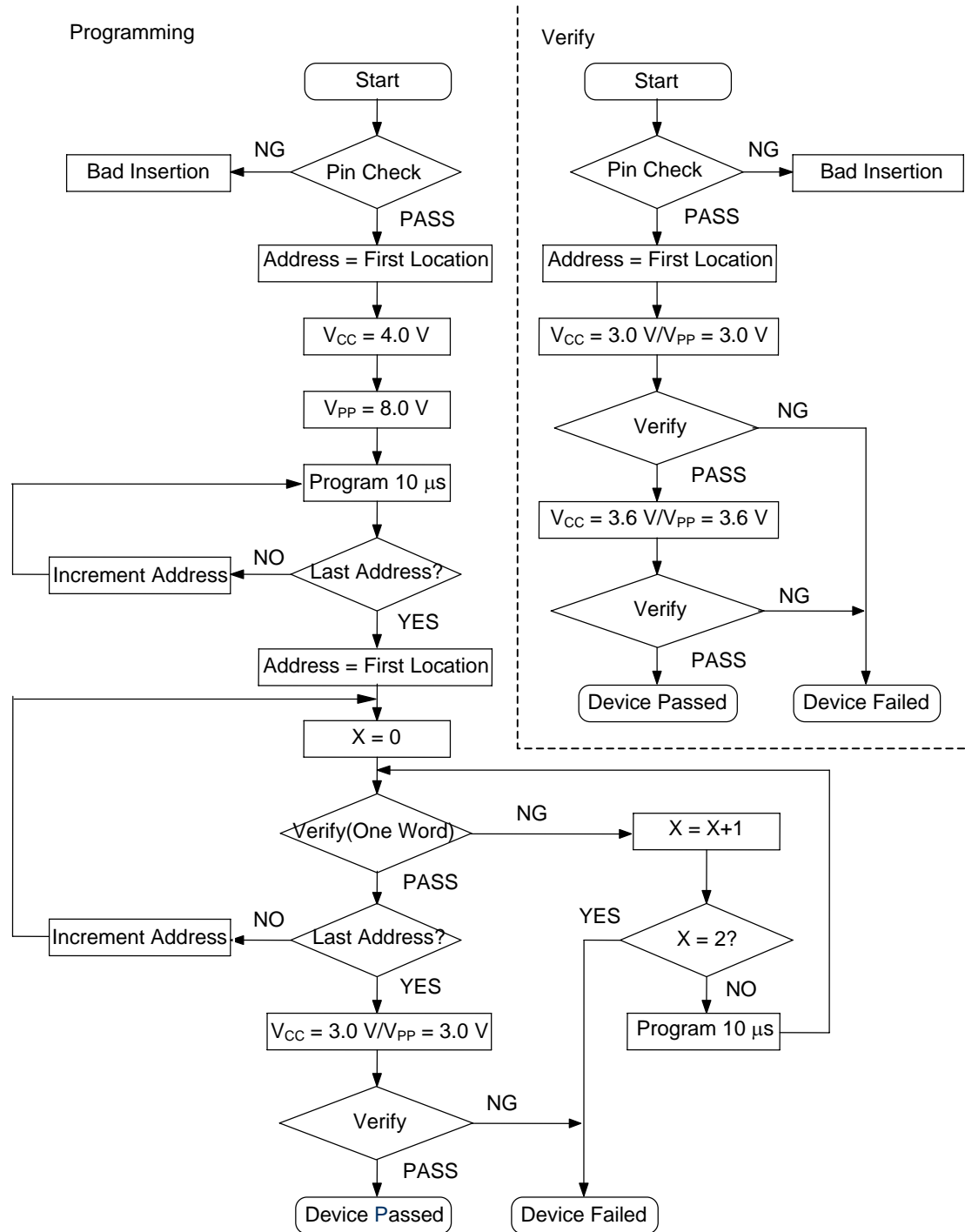


Pin Capacitance

($V_{CC} = 3.3\text{ V}$, $T_a = 25^\circ\text{C}$, $f = 1\text{ MHz}$)

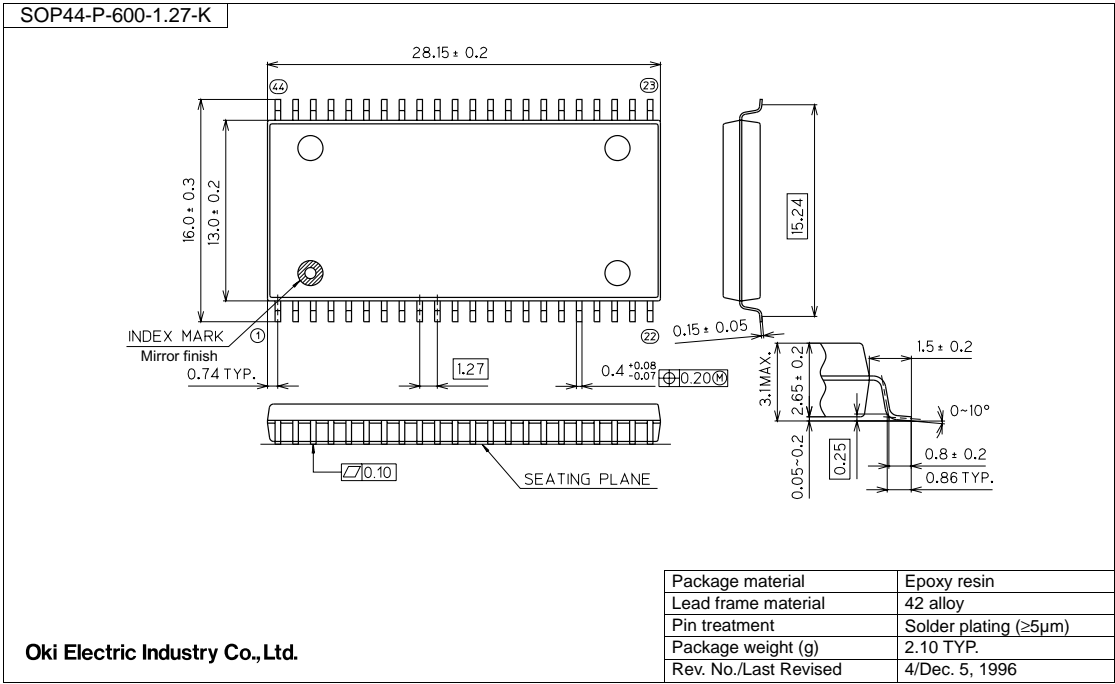
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input	C_{IN1}	$V_I = 0\text{ V}$	—	—	8	pF
BYTE#/V _{pp}	C_{IN2}		—	—	100	
Output	C_{OUT}	$V_O = 0\text{ V}$	—	—	10	

Programming/Verify Flow Chart



PACKAGE DIMENSIONS

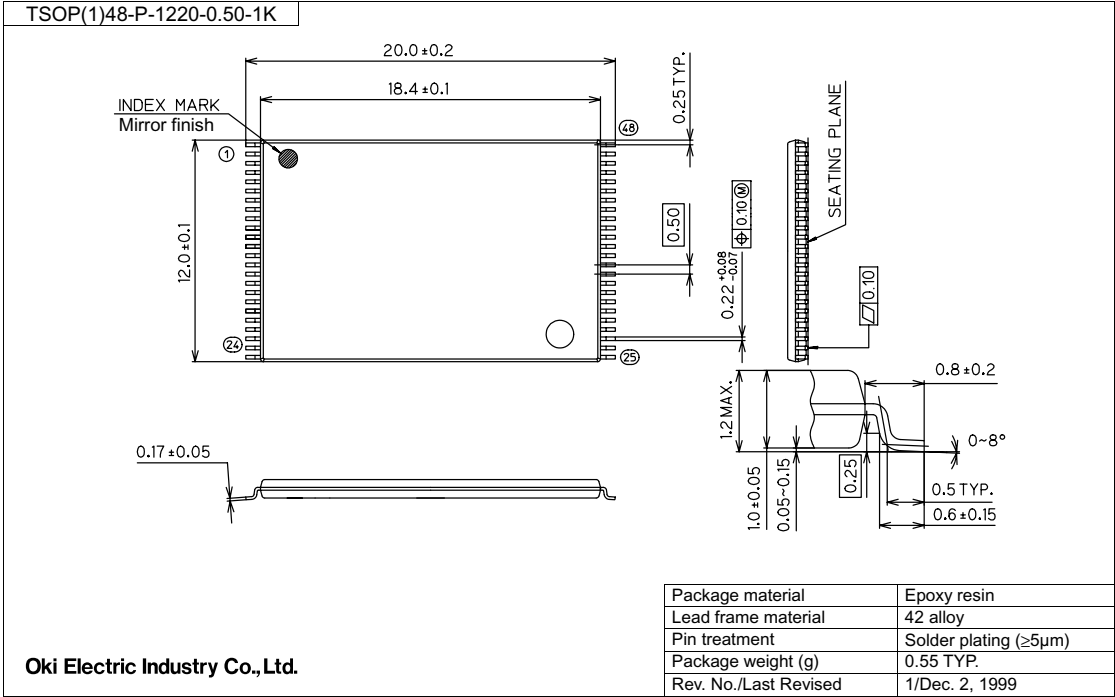
(Unit: mm)



Notes for Mounting the Surface Mount Type Package

The surface mount type packages are very susceptible to heat in reflow mounting and humidity absorbed in storage. Therefore, before you perform reflow mounting, contact Oki's responsible sales person for the product name, package name, pin number, package code and desired mounting conditions (reflow method, temperature and times).

(Unit: mm)

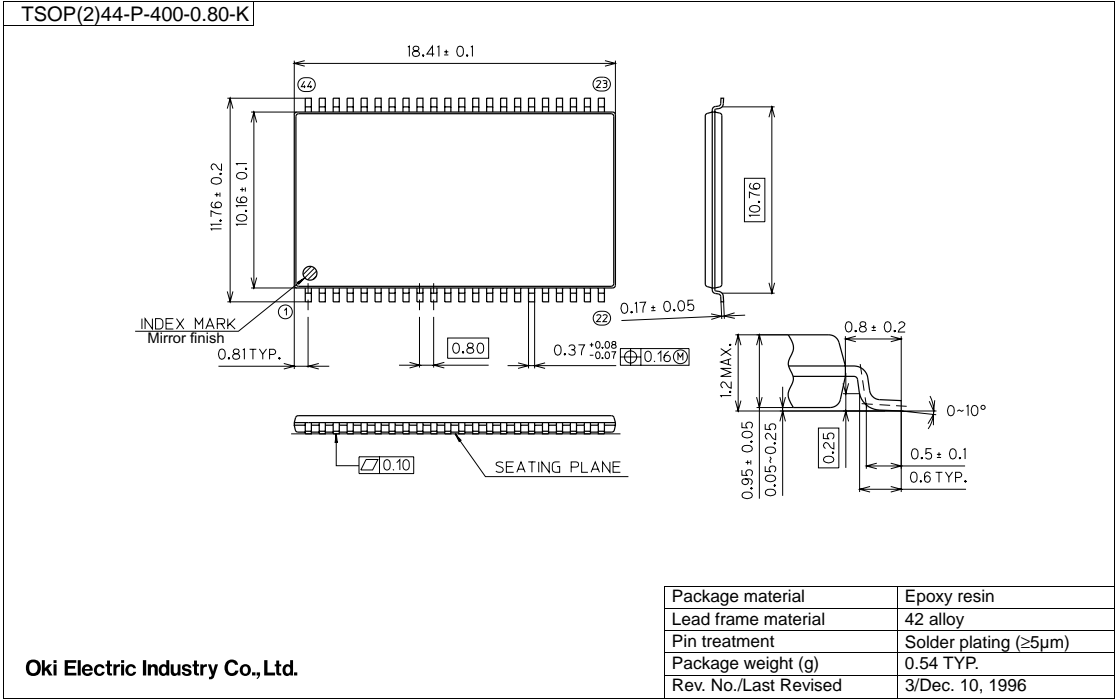


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REVISION HISTORY

Document No.	Date	Page		Description
		Previous Edition	Current Edition	
FEDR27V802F-01-01	Jan. 15, 2004	–	–	Final edition 1
FEDR27V802F-01-02	Jul. 9, 2004	1, 2 4	1, 2, 11 4	Add MR27V802FMA Add P_D condition and $I_{OS} = 10\text{mA}$
FEDR27V802F-01-03	Dec. 8, 2004	1, 2	1, 2, 13	Add MR27V802FTP

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